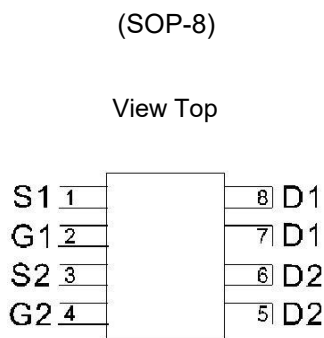


**MOSFET S)-(D 17V Channel-N Dual**  
**DESCRIPTION GENERAL**

power mode enhancement logic Channel-N Dual the is 9926A The DMOS density, cell high using produced are transistors effect field to tailored especially is process density high This technology. trench suited particularly are devices These resistance. state-on minimize notebook and phone cellular as such application voltage low for circuits powered battery other and management power computer very a in needed are loss power line-in low and switching where package. mount surface outline small

**CONFIGURATION PIN**

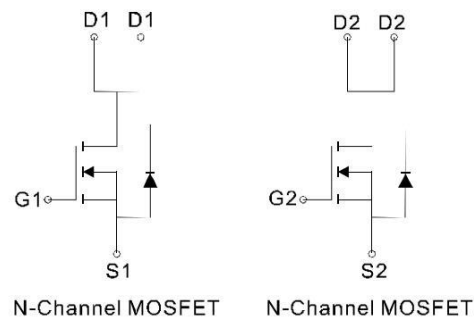


**FEATURES**

- $R_{DS(ON)} \leq 29m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} \leq 42m\Omega @ V_{GS}=2.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

**APPLICATIONS**

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- Load Switch
- DSC



Noted) Otherwise Unless  $^{\circ}C=25A(T$  Ratings Maximum Absolute

Parameter		Symbol	10sec	SteadyState	Unit		
Voltage Source-Drain		$d_{SS}V$	17		V		
Voltage Source-Gate		$g_{SS}V$	$\pm 8$		V		
*Current Drain Continuous	$^{\circ}C=25A(T$	$d_I$	6.6	5.2	A		
	$^{\circ}C=70A(T$		5.2	4.2			
Current Drain Pulsed		$d_{MI}$	30		A		
*Dissipation Power Maximum	$^{\circ}C=25A(T$	$d_P$	2.0	1.25	W		
	$^{\circ}C=70A(T$		1.2	0.8			
Temperature Junction Operating		$J_T$	150 to 55-		$^{\circ}C$		
*Ambient to Junction-Resistance Thermal		$\theta_{JAR}$	Typ	45	Typ	80	$^{\circ}C/W$
			Max	62.5	Max	100	

1in on mounted device The \* The <sup>2</sup>copper oz 2 with board FR4

**MOSFET S)-(D 17V Channel-N Dual**

Specified) Otherwise Unless °C=25 A(T Characteristics Electrical

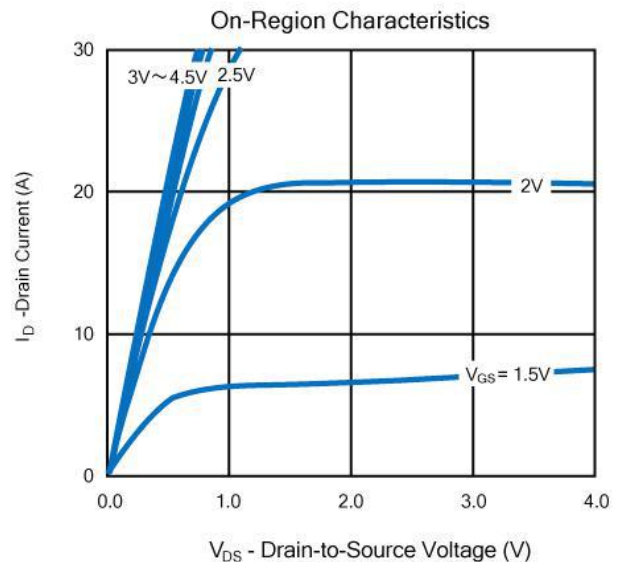
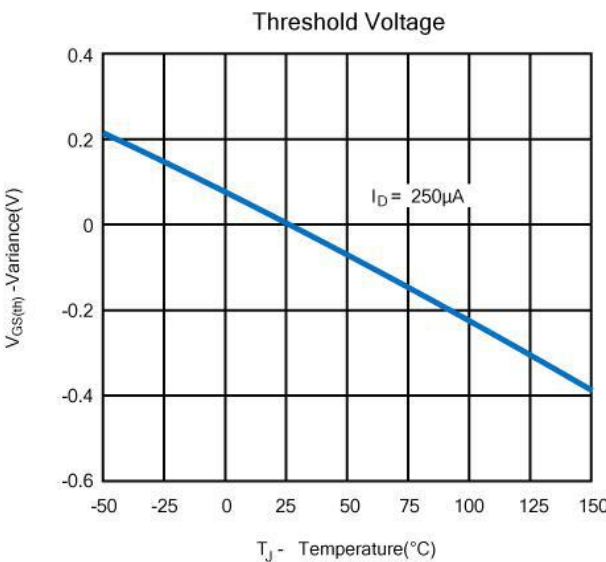
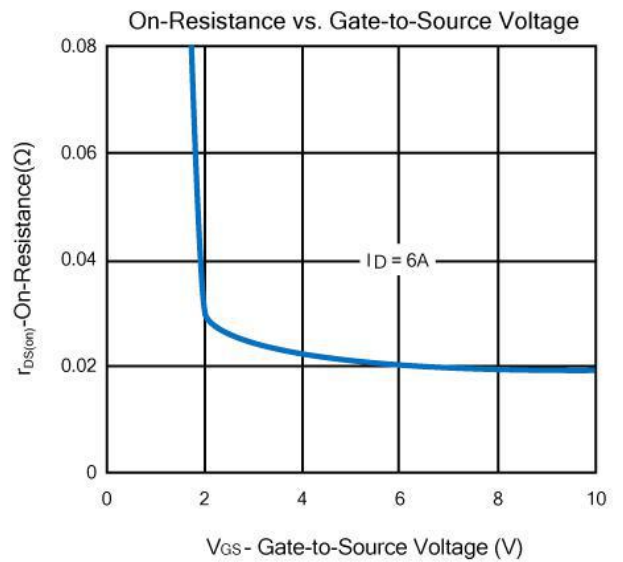
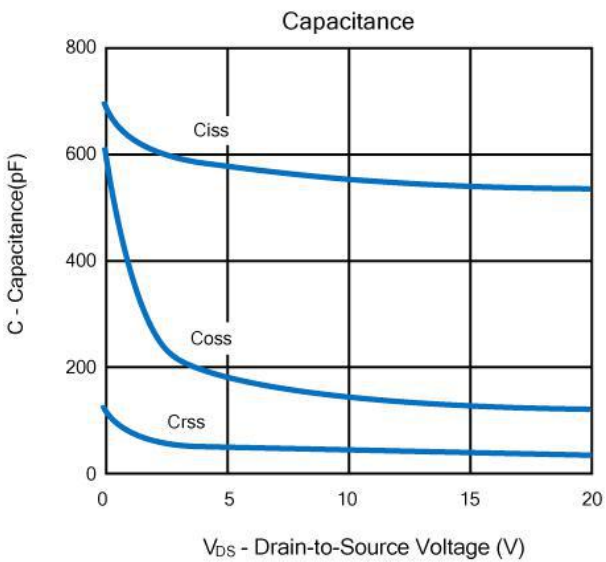
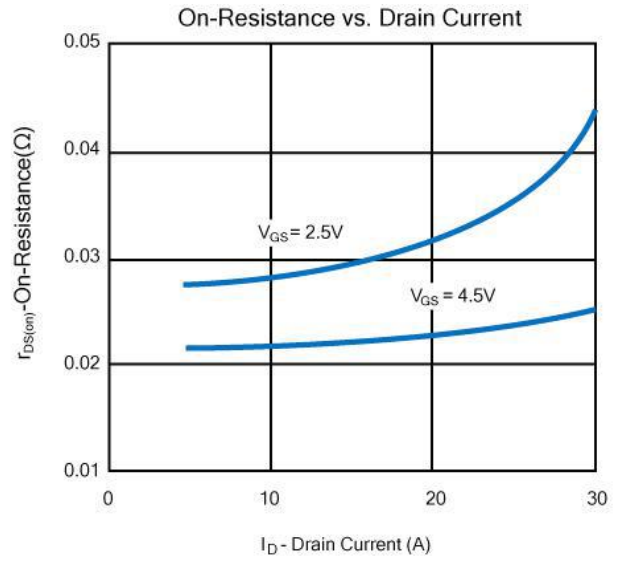
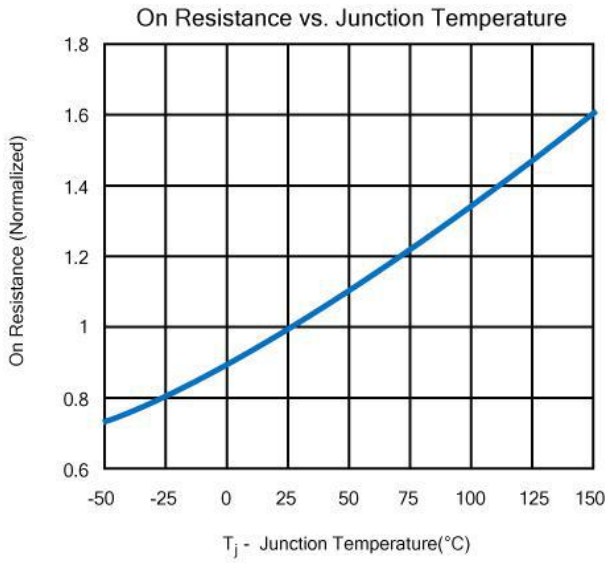
Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC</b>						
$V_{DS(BV)}$	Voltage Breakdown Source-Drain	$I_{\mu} = 250 \mu A, V_{GS} = 0V$	17			V
$V_{GS(th)}$	Voltage Threshold Gate	$I_{\mu} = 250 \mu A, V_{DS} = V_{GS}$	0.4		1.2	V
$I_{GSS}$	Leakage Body Gate	$V_{GS} = 8V, V_{DS} = 0V$			$\pm 100$	nA
$I_{DSS}$	Current Drain Voltage Gate Zero	$V_{GS} = 0V, V_{DS} = 17V$			1	$\mu A$
$R_{DS(on)}$	Resistance-On Source-Drain	$V_{GS} = 4.5V, I_D = 6.0A$			29	$\Omega$
		$V_{GS} = 2.5V, I_D = 5.2A$			42	
$V_{SD}$	Voltage Forward Diode	$V_{GS} = 0V, I_S = 1.7A$			1.2	V
<b>DYNAMIC</b>						
$Q_g$	Charge Gate Total	$I_D = 6.0A, V_{GS} = 4.5V, V_{DS} = 10V$		8		nC
$Q_{gs}$	Charge Source-Gate			2.1		
$Q_{gd}$	Charge Drain-Gate			2.3		
$t_{d(on)}$	Time Delay On-Turn	$V_{GS} = 4.5V, I_D = 1.0A, V_{DS} = 10V, I_{DD} = 60 \mu A$		14		ns
$t_r$	Time Rise On-Turn			17		
$t_{d(off)}$	Time Delay Off-Turn			43		
$t_f$	Time Fall Off-Turn			5		
$C_{iss}$	capacitance Input	$f = 1.0MHz, V_{GS} = 0V, V_{DS} = 15V$		550		pF
$C_{oss}$	Capacitance Output			130		
$C_{rss}$	Capacitance Transfer Reverse			40		

testing. production to subject not design, by 2%, Guaranteed  $\cong$  cycle duty 300us,  $\cong$  width pulse test: Pulse a. Notes:

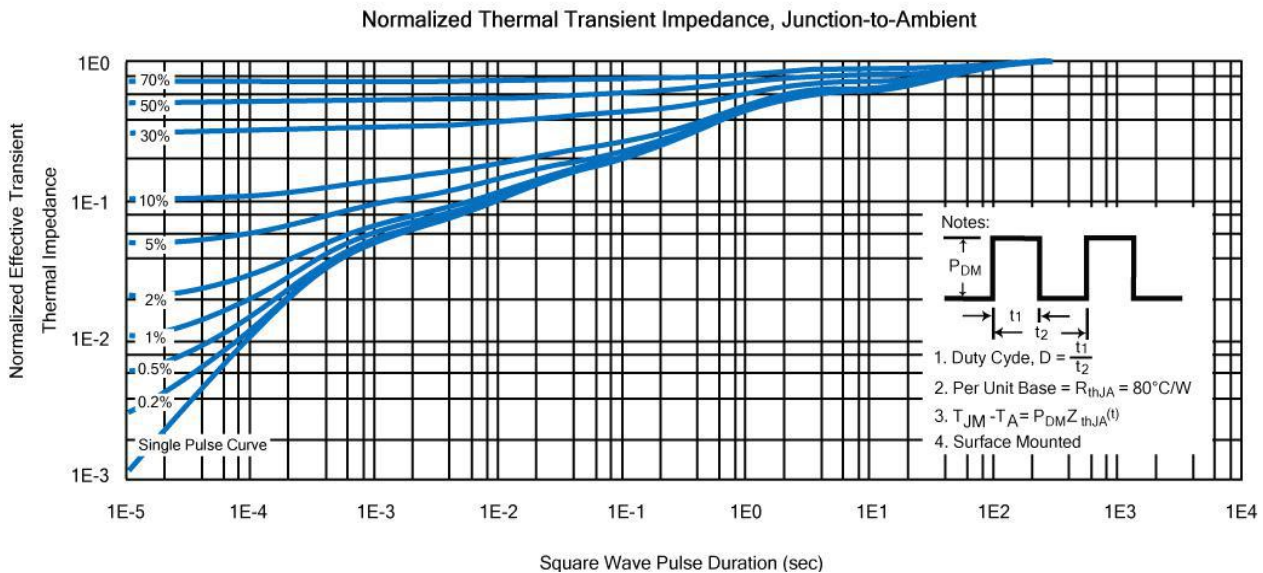
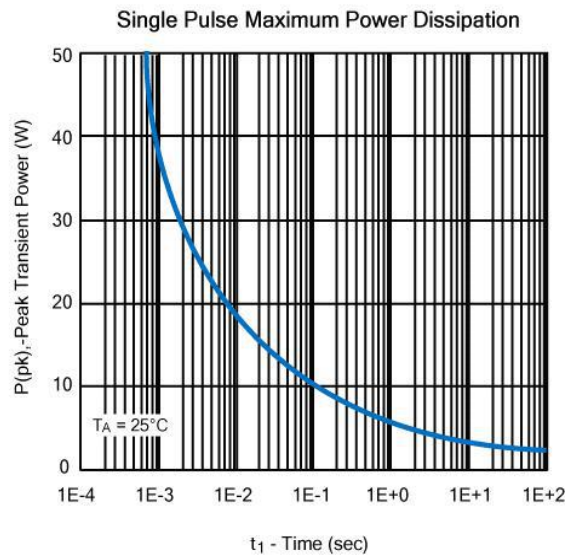
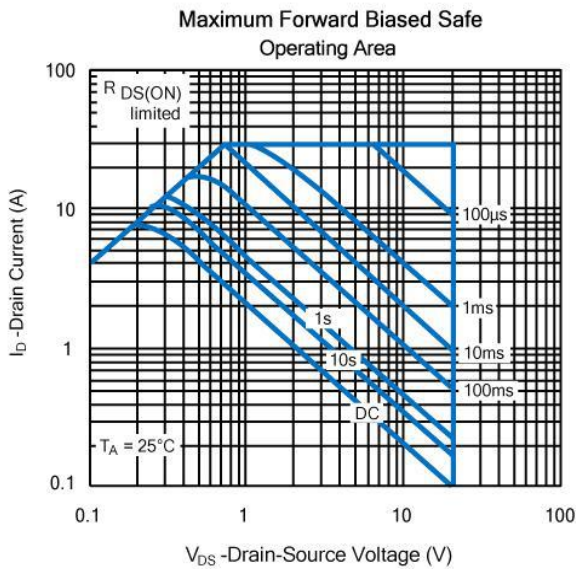
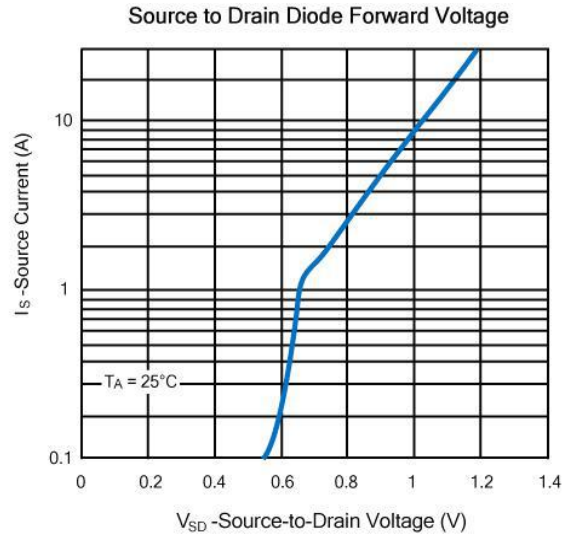
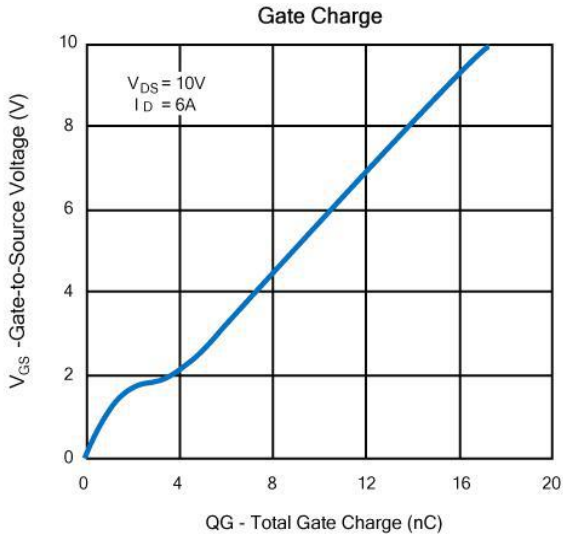
notice. without reliability and functions design, product improve to right the reserves b.suchtech

MOSFET S)-(D 17V Channel-N Dual

Noted) °C=25 J(T Characteristics Typical

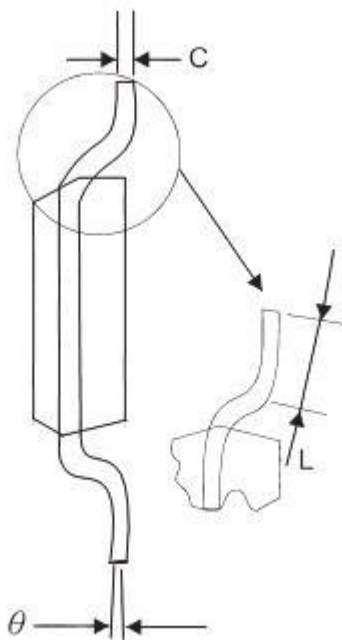
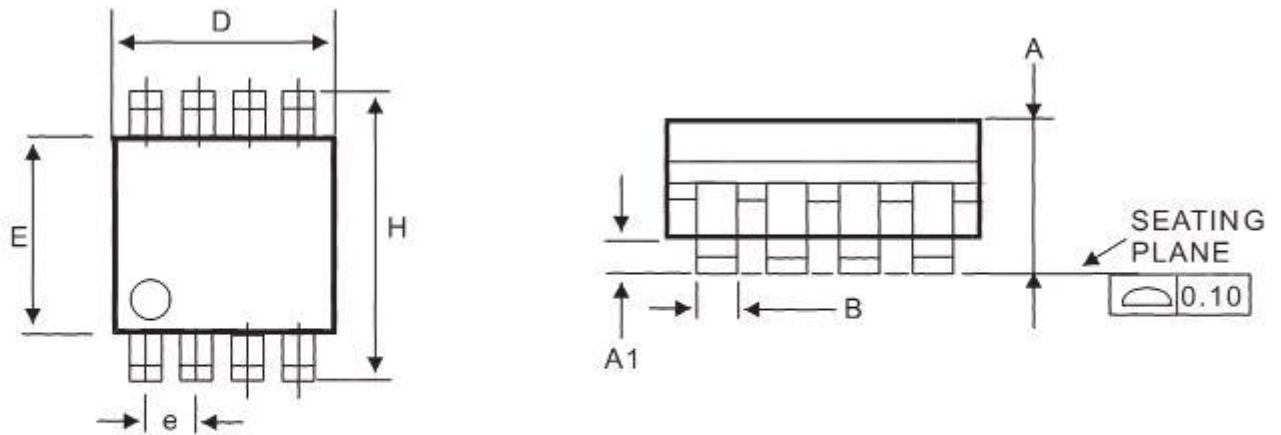


MOSFET S)-(D 17V Channel-N Dual  
 Noted) °C=25 J(T Characteristics Typical



MOSFET S)-(D 17V Channel-N Dual

Outline Package 8-SOP



DIM	(mm) MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.18	0.25
D	4.80	5.00
E	3.80	4.00
e	BSC 1.27	
H	5.80	6.20
L	0.40	1.25
$\theta$	0°	7°

012AA.-MS JEDEC to Refer 1. NNote:

2.

protrusions flash, mold include not does "D"

Dimension not shall burrs gate or protrusions flash.

Mold : burrs gate or side : per mm 0.15 exceed

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